

**DECLARATION
and POWER OF ATTORNEY**

☒ ORIGINAL
☐ CONTINUATION
☐ DIVISIONAL

As a below named inventor, I declare that the information given herein is true, that I believe that I am the original, first and sole inventor (if only one name is listed as 1 below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

THERMOPLASTIC POLYIMIDE RESIN FILM, MULTILAYER BODY AND METHOD FOR MANUFACTURING PRINTED WIRING BOARD COMPOSED OF SAME
the specification of which is attached hereto unless the following box is checked:

☒ was filed on December 12, 2003 as United States Application Number or PCT International Application Number PCT/JP2003/015928
and was amended on

My residence, post office address and citizenship are as stated below next to my name.

I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations § 1.56(a).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION (S)

COUNTRY	APPLICATION NUMBER	DATE OF FILING Month Day Year	PRIORITY CLAIMED UNDER 35 U.S.C. 119
Japan	2002-362485	December 13, 2002	Yes
Japan	2003-070696	March 14, 2003	Yes
Japan	2003-071058	March 14, 2003	Yes

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.)

(Filing Date)

(Status)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or Agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. ☒ Customer Number

Send correspondence to:

☒ Customer Number

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(Please Print)

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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 1 Shigeru TANAKA <i>Shigeru Tanaka</i>		Takashi ITOH <i>Takashi Itoh</i>	
DATE <i>May 16, 2005</i>		DATE <i>May 16, 2005</i>	
Masaru NISHINAKA <i>Masaru Nishinaka</i>		SIGNATURE OF INVENTOR 4 Kanji SHIMO-OHSAKO <i>Kanji Shimo-ohsako</i>	
DATE <i>May 16, 2005</i>		DATE <i>May 16, 2005</i>	
SIGNATURE OF INVENTOR 5 Mutsuaki MURAKAMI <i>Mutsuaki Murakami</i>		SIGNATURE OF INVENTOR 6	
DATE <i>May 16 2005</i>		DATE	